

INFORMATION DISCLOSURE CITATION IN AN APPLICATION

(Use several sheets if necessary)

Document Number (Optional)

MEG-02-015

Application Number

10/685,872

Applicant

M.S. Lin

Filing Date

10/15/03

Oral Art Unit

U. S. PATENT DOCUMENTS

| EXAMINER INITIAL | DOCUMENT NUMBER | DATE | NAME | CLASS | SUBCLASS | FILED DATE IF APPROPRIATE |
|---------------------|-----------------|----------|------------|-------|----------|------------------------------|
| W | 638391 | 6/5/02 | Lin | 438 | 637 | 2/17/99 |
| W | 6495442 | 12/17/02 | Lin et al. | 438 | 618 | 10/18/00 |
| W | 6303423 | 10/16/01 | Lin | 438 | 238 | 11/27/00 |
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FOREIGN PATENT DOCUMENTS

| | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUBCLASS | Translation | |
|--|-----------------|------|---------|-------|----------|-------------|----|
| | | | | | | YES | NO |
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

| | | |
|---|---|---|
| 2 | - | Multichip Module Technologies and Alternatives: the basics |
| | | Copyright 1993 by Van Nostrand Reinhold pp. 755 and 757. |
| 2 | - | MSL 98-002 CCC-CIP, serial number 10/154,662, |
| | | Filed 5/24/02, "Top Layers of Metal for High Performance IC's". |
| | | |
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EXAMINER

W. C. M. P. S. T.

DATE CONSIDERED

1/6/05

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 1.02; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.

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